

IN THE UNITED STATES PATENT AND TRADEMARK OFFICECommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith for filing is the patent application for inventor(s):

TATSUNARI MII

For: BUMP FORMATION METHOD AND WIRE BONDING METHOD


Also enclosed are:

- ☒ 6 sheets of drawings
- ☒ Certified copy of Japanese Patent Application No. 2003-038312 of February 17, 2003 on which Convention priority is claimed
- ☒ Declaration and Power of Attorney
- ☒ Information Disclosure Statement by Applicant
- ☒ An assignment of the invention to KABUSHIKI KAISHA SHINKAWA

☒ Applicant claims Small Entity Status

CALCULATION OF FEES								
ITEM		TOTAL NO. OF CLAIMS		NO. OF CLAIMS OVER BASE	LG/SM \$ ENTITY FEE		\$ AMOUNT	\$ FEE
A	TOTAL CLAIMS FEE	4	-20	0	LG=\$18 SM=\$9	\$9	\$ 0	
B	INDEPENDENT CLAIMS FEE*	4	-3	1	LG=\$86 SM=\$43	\$43	\$ 43	
C	SUBTOTAL - ADDITIONAL CLAIMS FEE (ADD FINAL COLUMN IN LINES A + B)							\$ 43
D	MULTIPLE-DEPENDENT CLAIMS FEE					LARGE ENTITY FEE = \$290 SMALL ENTITY FEE = \$145		\$ 0
E	BASIC FEE					LARGE ENTITY FEE = \$770 SMALL ENTITY FEE = \$385		\$ 385
F	TOTAL FILING FEE (ADD TOTALS FOR LINES C, D, AND E)							\$ 428
G	ASSIGNMENT RECORDING FEE						\$ 40	\$ 40
	*LIST INDEPENDENT CLAIMS 1-4							

- ☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Account No. 11-1445. A duplicate copy of this sheet is enclosed.
- ☒ A check in the amount of \$ 428 to cover the filing fee is enclosed.
- ☒ A check in the amount of \$ 40 to cover Assignment Recordation fee is enclosed.

Respectfully submitted,
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on February 17, 2004 by Inja Yi.

Dated: 2/17/04

By: 

85A 3503

SHINKAWA

Applicant(s):

TATSUNARI MII

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